



Material	PM0603 SERIES			
Product Line	Wire Wound Chip Inductor			
Date	12-September-2006			

No.	Construction element	Material group	Material Weight [g]	Materials	CAS if applicable	Average mass [%]	Sum [%]	Traces
1	Ceramic Core	Ceramic	0.0039	Al <sub>2</sub> O <sub>3</sub>	07429-90-5	88	100	
				SiO <sub>2</sub>	11126-22-0	7		
				CaO	01305-78-8	2		
				MgO <sub>2</sub>	07349-95-4	0.95	-	
				Мо	7439-98-7	0.5	-	
				Mn	7439-96-5	0.5		
				Ni	7440-02-0	1	-	
				Au	7440-57-5	0.05	-	
2	Copper Wire	Copper	0.0005	Cu	7440-50-8	100	100	
3	Ероху	UV epoxy	0.0005	Hydroxycyclonexy -Ketonel	000947-19-3	3	100	
				Epoxy Acrylate	42978-66-5	52		
				Monomer	42978-66-5	45	-	
1		Total weight	0.0049			•		

## **MATERIAL DECLARATION SHEET**



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## Important remarks:

- 1. Traces are product parts substances etc. that are below a percentage of 0.1% of total weight.
- 2. A list of the legally regulated substances or materials is available at internet address <u>http://www.eicta.org/content.asp?pageID=113</u>
- 3. Substances, materials etc. with possible harm to men and environment are listed.
- 4. There are no risks for human beings and to the environment if products are used properly as designated. This shall not apply to risks caused during procedures for disposal etc.
- 5. All statements herein are based on our present knowledge.